### **Slotted Switch**

### OPB885Z

# **Electronics**

#### Features:

- 24" (610 mm) long 26 gauge wired assembly
- Non-contact infrared switch
- Opaque plastic housing
- 0.375" (9.5 mm) slot width
- 0.595" (15.1 mm) slot depth



#### **Description:**

OPB885Z uses an Infrared LED and a phototransistor in a slotted switch configuration. The assembly has 24" (610mm) 26 AWG wires on each terminal and uses an opaque housing to reduce the sensor's ambient light sensitivity. Each discrete has an 0.050" (1.27 mm) aperture that focuses the switching sensitivity and limits ambient light absorption by the phototransistor. The housing is made from an opaque plastic with IR transmissive plastic in the front of each aperture to provide dust protection.

In the normal unobstructed slot, infrared light from the LED, radiates the phototransistor and becomes forward biased and is considered to be in the "on" state, providing an I<sub>C(ON)</sub> current that is proportional to the light striking the phototransistor. As the light is blocked by using an opaque object that blocks the infrared light from the LED to the phototransistor, the phototransistor turns "off," minimizing the  $I_{C(ON)}$  current and thus allowing the electrical state to be considered switched.

Custom electrical, wire and cabling and connectors are available. Contact your local representative or OPTEK for more information.

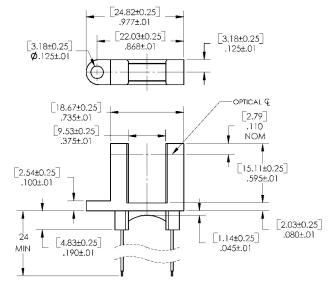
### **Applications:**

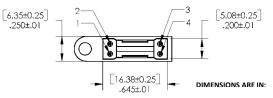
- Non-contact interruptive object sensor
- Assembly line automation
- Machine automation
- **Equipment security**
- Machine safety
- End of travel sensor
- Door sensor

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Ordering Information				
Part Number	Description			
OPB885Z	Non-contact infrared switch			

Pin #	Description	
White-1	Collector	
Green-2	Emitter	
Red-3	Anode	
Black-4	Cathode	





[ MILLIMETERS]

INCHES

General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

TT Electronics | OPTEK Technology 2900 E. Plano Pkwy, Plano, TX 75074 | Ph: +1 972 323 2200 www.ttelectronics.com | sensors@ttelectronics.com

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### **Electrical Specifications**

#### Absolute Maximum Ratings (T<sub>A</sub> = 25° C unless otherwise noted)

Storage Temperature	-40° C to +100° C
Operating Temperature	-40° C to +85° C
Lead Soldering Temperature (1/16 inch (1.6 mm) from the case for 5 sec. with soldering iron) <sup>(2)</sup>	260° C
LED	LED
Forward Current	50 mA
Peak Forward Current (2 μs pulse width, 0.1% duty cycle)	1 A
Reverse DC Voltage	3 V
Power Dissipation	100 mW
Output Phototransistor	Output Phototransistor
Collector-Emitter Voltage	30 V
Collector DC Current	50 mA
Power Dissipation	100 mW

#### Electrical Characteristics (T<sub>A</sub> = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS	
Input Diode	Input Diode						
V <sub>F</sub>	Forward Voltage	-	-	1.7	V	I <sub>F</sub> = 20 mA	
I <sub>R</sub>	Reverse Current	-	-	100	μΑ	V <sub>R</sub> = 3 V	
Output Phototransistor							
$BV_CEO$	Collector-Emitter Breakdown Voltage	30	-	-	٧	I <sub>C</sub> = 1 mA	
I <sub>CEO</sub>	Collector-Emitter Dark Current	-	-	100	nA	V <sub>CE</sub> = 10 V	
Combined							
V <sub>CE(SAT)</sub>	Collector-Emitter Saturation Voltage	-	-	0.6	V	I <sub>C</sub> = 1 mA, I <sub>F</sub> = 20 mA	
I <sub>C(ON)</sub>	On-State Collector Current	1.3	-	8	mA	V <sub>CE</sub> = 5 V, I <sub>F</sub> = 20 mA	

#### Notes:

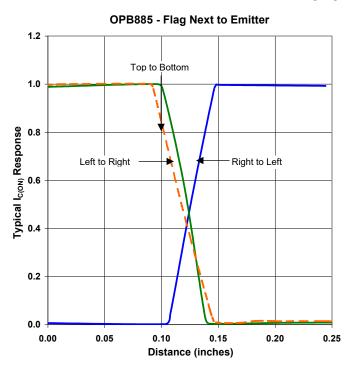
- (1) All parameters tested using pulse technique.
- (2) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.
- (3) Methanol or isopropanol are recommended as cleaning agents. The plastic housing is soluble in chlorinated hydrocarbons and keytones.

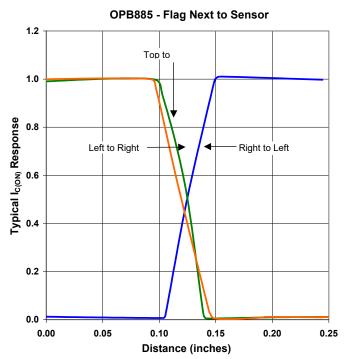
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### **Performance**





#### OPB885 - Flag in Middle of Slot

